







PRODUCT DATASHEET



- ► PLCC2 Top View SMD
- ▶ 2214 1.3t
- ► Warm White 2960K

N0W49S05Z





2214 1.3t Series





Release Date: 28 May 2022 Version: A1.1



FEATURES:

- Package: PLCC2 Single Colour Top View SMD
- Forward Current: 20mA
- Forward Voltage (typ.): 3.1V
- Luminous Intensity (typ.): 2000mcd@20mA
- Colour: Warm White
- Colour Temperature (CCT): 2760~3160K
- Viewing angle: 120°
- Materials:
 - Die: InGaN
 - Resin: Silicone (Yellow Diffused)
 - Finishing: Ag plated
- Operating Temperature: -40~+105°C
- Storage Temperature: -40~+105°C
- **ESD (HBM):** 6KV
- Grouping parameters:
 - Forward voltage
 - Luminous intensity
 - CIE Chromaticity
- Soldering methods: Reflow
- MSL: acc. to JEDEC Level 2a
- Packing: 8mm tape with max.3000/reel, ø180mm (7")

APPLICATIONS:

- Automotive
- Backlighting
- Indication Light
- Switch light
- Dashboard
- Decoration Lighting



CHARACTERISTICS:

Absolute Maximum Characteristics (Ta=25°C)

Parameter	Symbol	Ratings	Unit
Forward Current	lf	30	mA
Peak Forward Current Duty 1/10; width 0.1ms	I _{FP}	100	mA
Reverse Voltage	V _R	5	V
Reverse Current @5V	I _R	10	μΑ
Junction Temperature	Tj	115	°C
Thermal Resistance Junction to Solder Point	R _{th}	160	°C/W
Operating Temperature	T _{OPR}	-40~+105	°C
Storage Temperature	T _{STG}	-40~+105	°C

Electrical & Optical Characteristics (Ta=25°C)

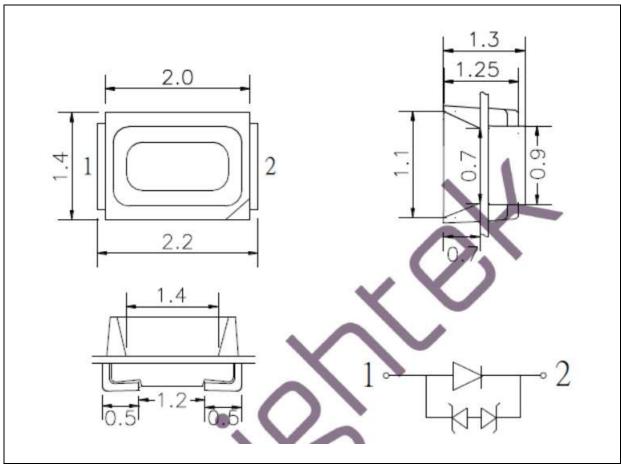
Darameter	Cumbal	Values			Unit	Test	
Parameter	Symbol	Min.	Тур.	Max.	Unit	Condition	
Forward Voltage	V_{F}	2.7		3.5	V	I _F =20mA	
Luminous Intensity	lv	1650	2000		mcd	I _F =20mA	
Chromaticity	Х		0.4370			I _F =20mA	
Coordinates	Υ		0.4050				
Colour Temperature	ССТ	2760	2960	3160	К	I _F =20mA	
Viewing Angle	2θ _{1/2}		120		deg	I _F =20mA	

^{1.} Luminous intensity (I_V) $\pm 10\%$, Forward Voltage (V_F) ± 0.1 V.



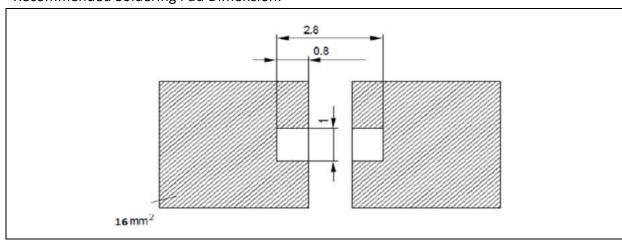
OUTLINE DIMENSION:

Package Dimension:



- 1. All dimensions are in millimetre (mm).
- 2. Tolerance ±0.2mm, unless otherwise noted.

Recommended Soldering Pad Dimension:



- 1. Dimensions are in millimetre (mm).
- 2. Tolerance ±0.1mm with angle tolerance ±0.5°.



BINNING GROUPS:

Forward Voltage Classifications (I_F = 20mA):

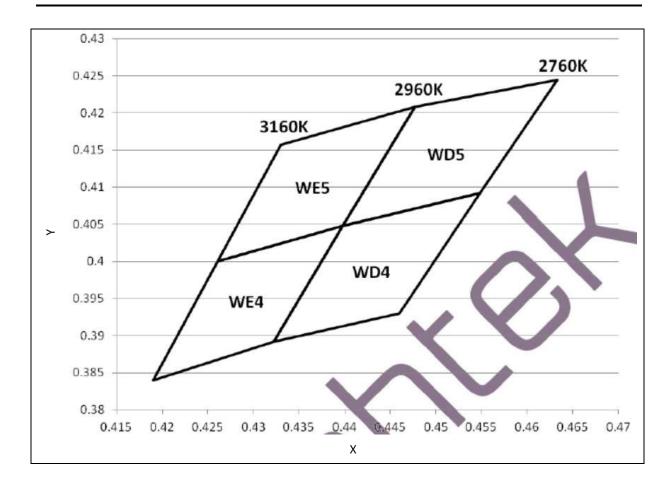
Code	Min.	Max.	Unit
А	2.7	2.8	
В	2.8	2.9	
С	2.9	3.0	
D	3.0	3.1	V
E	3.1	3.2	V
F	3.2	3.3	
G	3.3	3.4	
Н	3.4	3.5	

Luminous Intensity Classifications (I_F = 20mA):

Code	Min.	Max.	Unit	
4	1650	1850		
5	1850	2050	mad	
6	2050	2250	mcd	
7	2250	2450		



CIE CHROMATICITY DIAGRAM:

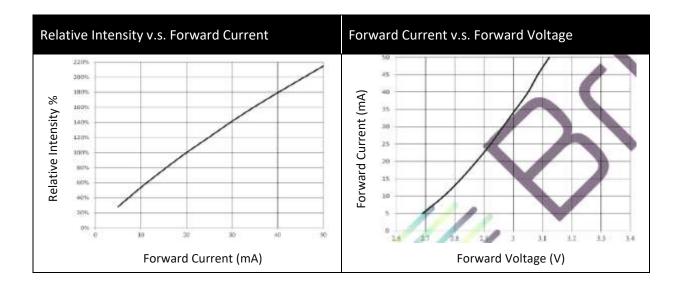


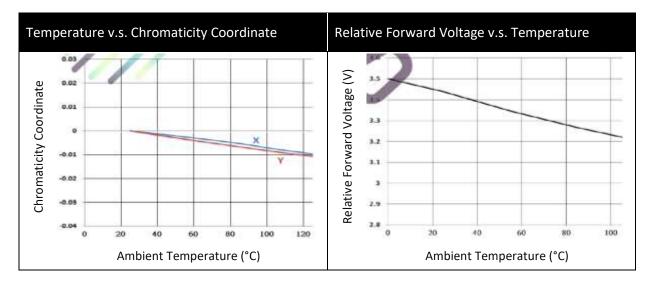
Chromaticity Coordinates Classifications (I_F = 20mA):

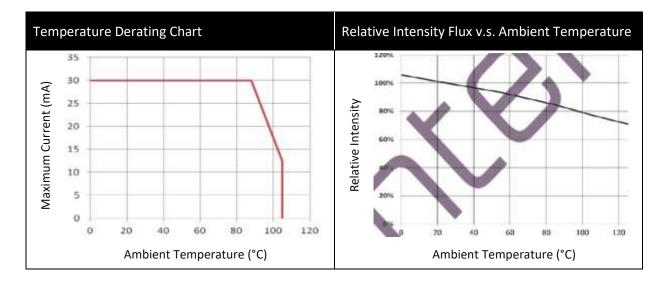
	1	1	2		3		4	
	Х	Y	Х	Y	Х	Y	Х	Υ
WD5	0.4477	0.4208	0.4398	0.4048	0.4548	0.4092	0.4633	0.4245
WD4	0.4398	0.4048	0.4322	0.3892	0.4460	0.3930	0.4548	0.4092
WE5	0.4330	0.4157	0.4261	0.4000	0.4398	0.4048	0.4477	0.4208
WE4	0.4261	0.4000	0.4190	0.3840	0.4322	0.3892	0.4398	0.4048



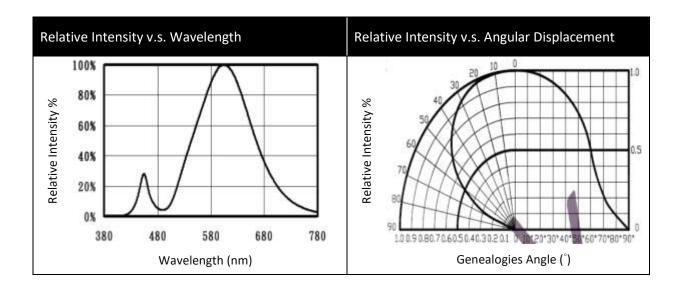
ELECTRO-OPTICAL CHARACTERISTICS:







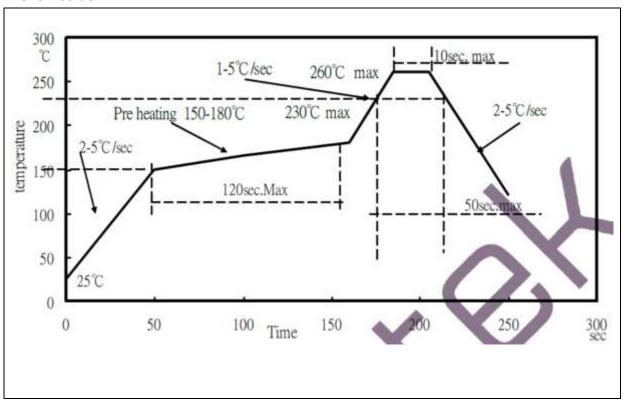






RECOMMENDED SOLDERING PROFILE:

Reflow solder:



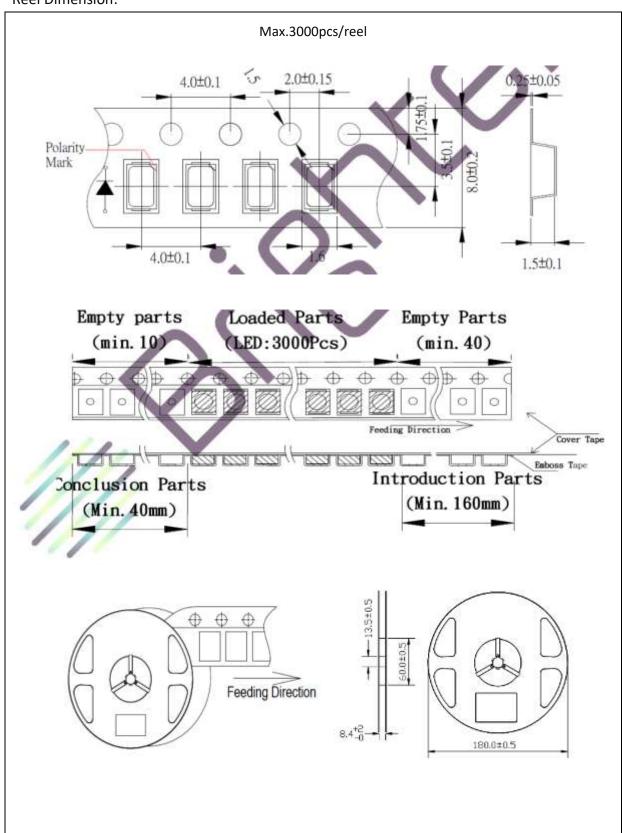
Note:

- 1. Recommend reflow temperature 240°C. The maximum soldering temperature should be limited to 260°C.
- 2. Maximum reflow soldering: 3 times.
- 3. Before, during, and after soldering, should not apply stress on the components and PCB board.



PACKING SPECIFICATION:

Reel Dimension:





PRECAUTIONS OF USE:

Storage:

It is recommended to store the products in the following conditions:

- Humidity: 60% R.H. Max.
- Temperature: 5°C~30°C (41°F ~86°F).

Shelf life in sealed bag: 12 months at 5°C~30°C and <60% R.H.

Once the package is opened, the products should be used within 4 weeks. Otherwise, they should be kept in a damp-proof box with descanting agent <10% R.H. and apply baking before use.

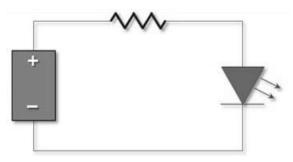
Baking:

It is recommended to bake the LED before soldering if the pack has been unsealed for longer than 24hrs. The suggested baking conditions are as followings:

• 60±3°C x 6hrs and <5%RH, taped / reel package.

It's normal to see slight color fading of carrier (light yellow) after baking in process.

Testing Circuit:



Must apply resistor(s) for protection (over current proof).

Cleaning:

Use alcohol-based cleaning solvents such as isopropyl alcohol to clean the LED carrier / package. Avoid putting any stress force directly on to the LED lens.

ESD (Electrostatic Discharge):

Static Electricity or power surge will damage the LED. Use of a conductive wrist band or anti-electrosatic glove is recommended when handing the LED all time. All devices, equipment, machinery, work tables, and storage racks must be properly grounded.

In the events of manual working in process, make sure the devices are well protected from ESD at any time.



REVISION RECORD:

Version	Date	Summary of Revision
A1.0	15/05/2019	Datasheet set-up.
A1.1	28/05/2022	New datasheet format.